

DESOLDERING DEVICES

VAC X and SOLDAPULLT AS 196



VAC X desoldering device

The **VAC X** desoldering device is distinguished by its high suction power and low-recoil desoldering. The antistatic design allows desoldering work on electrostatically endangered assemblies. Due to the long and

slim desoldering tips, the VAC X can also be used on densely populated PCBs.



SOLDAPULLT AS 196 desoldering device

The **SOLDAPULLT AS 196** model is distinguished by extremely good recoil damping and has proven its merit many times over in industry. The dual seal ring system guarantees constant suction power on a high level.

Order information:

Order no.	Description	Desoldering tips	Suction capacity
0VACX	VAC X antistatic desoldering device	0VACX2 (2 pcs.)	11.3 cm ³
0AS196	SOLDAPULLT AS 196 antistatic desoldering device	0LS197	34 cm ³

VACUUM PIPETTE

SVP 100

The **SVP 100** vacuum pipette can be used to handle nearly all components, except MELFs and MINI-MELFs. This tool consists of a nickel-plated aluminum handle, sealed at the rear end by a plug.

When opened, replacement tips and suction cups can be stored here.



Vacuum pipette SVP 100

Order information:

Order no.	Description	Length	ø Housing diameter	ø Cup diameters	Weight
0SVP100	SVP 100 vacuum pipette, complete, with bent tip 0SVP12K and 3 silicone cups 0SVP13A	150 mm	14 mm	4 mm, 6 mm, 9 mm	60 g